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Correction: 3D polymer objects with electronic components interconnected *via* conformally printed electrodes

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Correction for '3D polymer objects with electronic components interconnected *via* conformally printed electrodes' by Yejin Jo, *et al.*, *Nanoscale*, 2017, **9**, 14798–14803.

(1) On page 14799, left column, the sentence beginning “The thermoplastic SIS tri-block copolymer...” contains an incorrect temperature value. The correct sentence should read “The thermoplastic SIS tri-block copolymer, which consists of isoprene segments with glass transition temperature below -60 °C, promotes good adhesion properties to the underlying 3D polymer surfaces¹⁷ (Fig. S1†).

(2) In Fig. 1a of the published article, the chemical ratio $(x + z) : y = 22 : 88$ is incorrect. The correct ratio should be given as $(x + z) : y = 22 : 78$.

The Royal Society of Chemistry apologises for these errors and any consequent inconvenience to authors and readers.

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